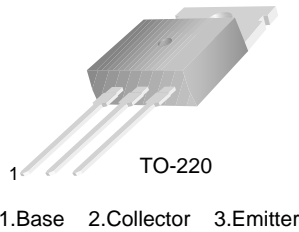


# FJP13009

## High Voltage Fast-Switching NPN Power Transistor

- High Voltage Capability
- High Switching Speed
- Suitable for Electronic Ballast and Switching Mode Power Supply



### Absolute Maximum Ratings\* $T_C = 25^\circ\text{C}$ unless otherwise noted (notes\_1)

Symbol	Parameter	Value	Units
$V_{CBO}$	Collector-Base Voltage	700	V
$V_{CEO}$	Collector-Emitter Voltage	400	V
$V_{EBO}$	Emitter-Base Voltage	9	V
$I_C$	Collector Current (DC)	12	A
$I_{CP}$	Collector Current (Pulse)	24	A
$I_B$	Base Current	6	A
$P_C$	Collector Dissipation ( $T_C = 25^\circ\text{C}$ )	100	W
$T_J$	Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-65 ~ 150	$^\circ\text{C}$

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES\_1:

- 1) These ratings are based on a maximum junction temperature of  $150^\circ\text{C}$ .
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Package Marking and Ordering Information

Device Item (notes_2)	Device Marking	Package	Packing Method	Qty(pcs)
FJP13009	J13009	TO-220	Bulk	1,200
FJP13009H2TU	J130092	TO-220	TUBE	1,000
FJP13009TU	J13009	TO-220	TUBE	1,000

#### Notes\_2 :

- 1) The Affix "-H2" means the hFE classification.
- 2) The Suffix "-TU" means the Tube packing method, which can be on fairchildsemi website at <http://www.fairchildsemi.com/packaging>.

### Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max	Units
V <sub>CEO(sus)</sub>	Collector-Emitter Sustaining Voltage	I <sub>C</sub> = 10mA, I <sub>B</sub> = 0	400			V
I <sub>EBO</sub>	Emitter Cut-off Current	V <sub>EB</sub> = 9V, I <sub>C</sub> = 0			1	mA
h <sub>FE</sub>	* DC Current Gain	V <sub>CE</sub> = 5V, I <sub>C</sub> = 5A (h <sub>FE1</sub> ) V <sub>CE</sub> = 5V, I <sub>C</sub> = 8A	8 6		40 30	
V <sub>CE(sat)</sub>	* Collector-Emitter Saturation Voltage	I <sub>C</sub> = 5A, I <sub>B</sub> = 1A I <sub>C</sub> = 8A, I <sub>B</sub> = 1.6A I <sub>C</sub> = 12A, I <sub>B</sub> = 3A			1 1.5 3	V V V
V <sub>BE (sat)</sub>	* Base-Emitter Saturation Voltage	I <sub>C</sub> = 5A, I <sub>B</sub> = 1A I <sub>C</sub> = 8A, I <sub>B</sub> = 1.6A			1.2 1.6	V V
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> = 10V, f = 0.1MHz		180		pF
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> = 10V, I <sub>C</sub> = 0.5A	4			MHz
t <sub>ON</sub>	Turn On Time	V <sub>CC</sub> = 125V, I <sub>C</sub> = 8A			1.1	μs
t <sub>STG</sub>	Storage Time	I <sub>B1</sub> = - I <sub>B2</sub> = 1.6A, R <sub>L</sub> = 15,6Ω			3	μs
t <sub>F</sub>	Fall Time				0.7	μs

\* Pulse Test: PW ≤ 300μs, Duty Cycle ≤ 2%

### h<sub>FE</sub> Classification

Classification	H1	H2
h <sub>FE1</sub>	8 ~ 17	15 ~ 28

## Typical Performance Characteristics

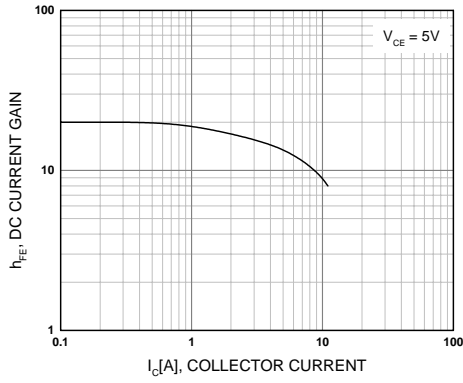


Figure 1. DC current Gain

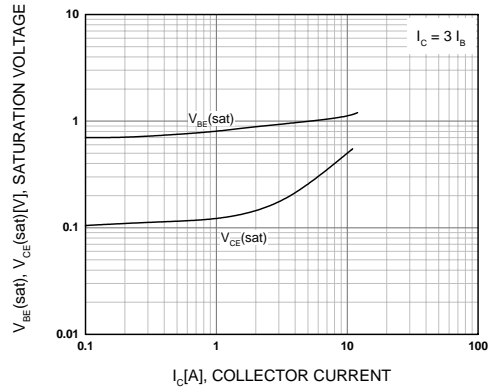


Figure 2. Base-Emitter Saturation Voltage  
Collector-Emitter Saturation Voltage

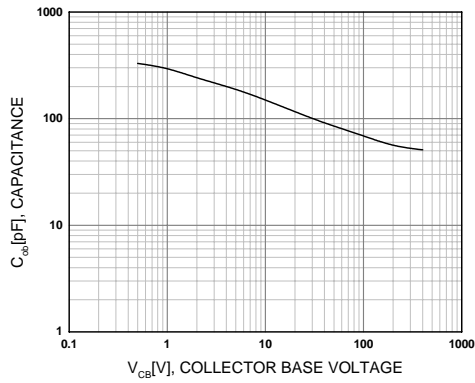


Figure 3. Collector Output Capacitance

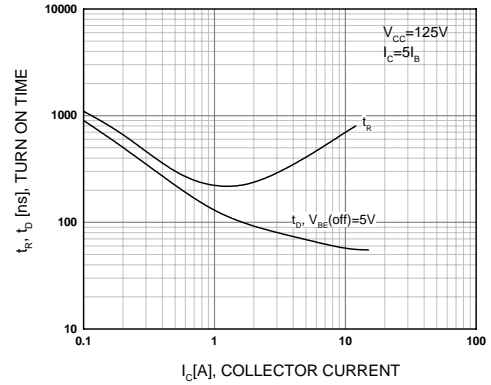


Figure 4. Turn On Time

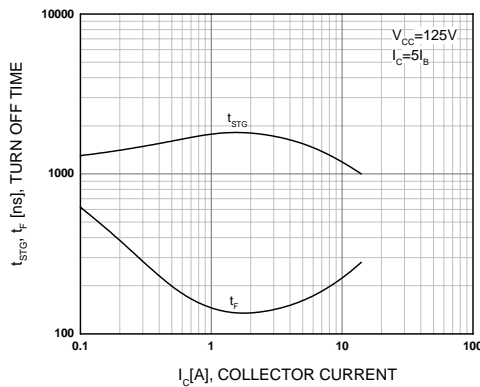


Figure 5. Turn Off Time

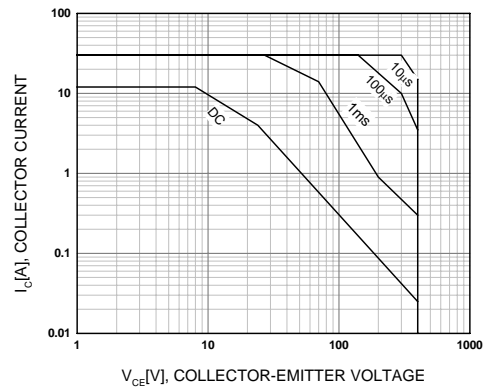
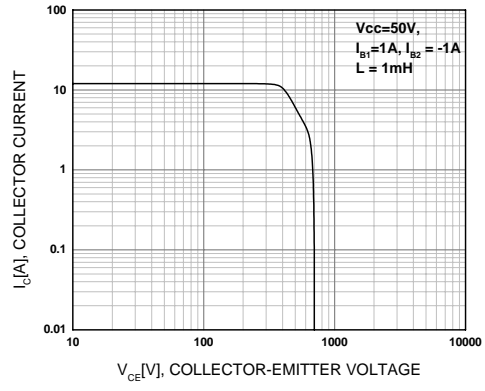
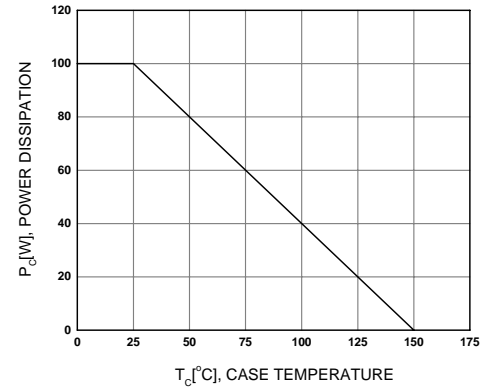


Figure 6. Forward Bias Safe Operating Area

**Typical Performance Characteristics** (Continued)



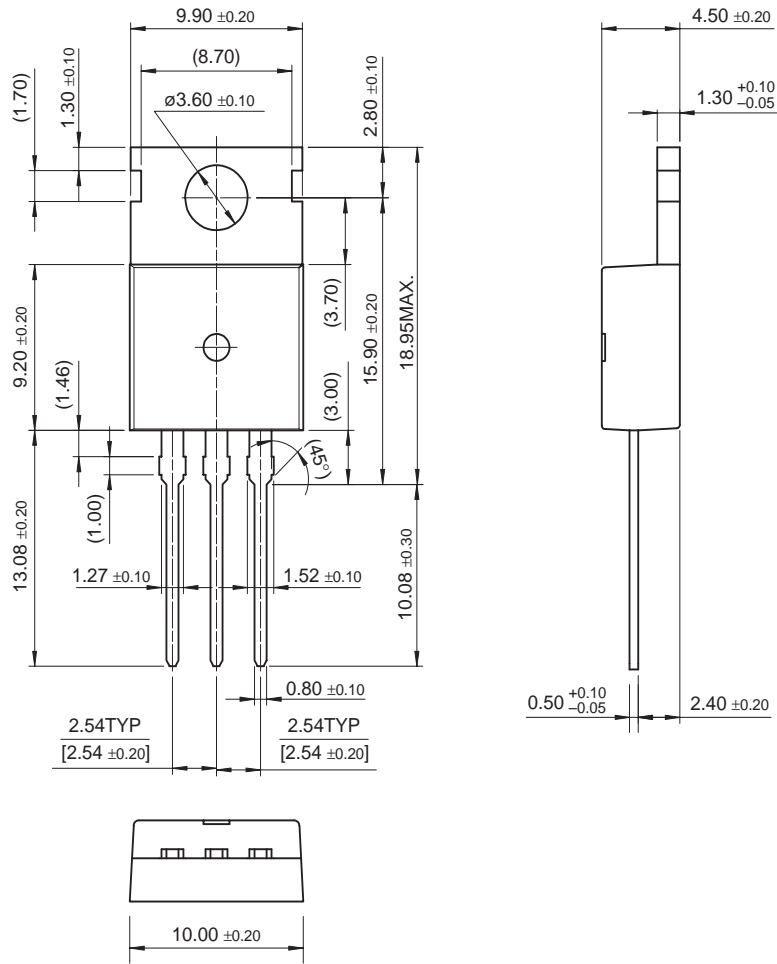
**Figure 7. Reverse Bias Safe Operating Area**



**Figure 8. Power Derating**

### Mechanical Dimensions

### TO-220




Dimensions in Millimeters



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Current Transfer Logic™	MSX™	SMART START™	VCX™
DOME™	MSXPro™	SPM®	Wire™
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EcoSPARK®	OCXPro™	SuperFET™	
EnSigna™	OPTOLOGIC®	SuperSOT™-3	
FACT Quiet Series™	OPTOPLANAR®	SuperSOT™-6	
FACT®	PACMAN™	SuperSOT™-8	
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